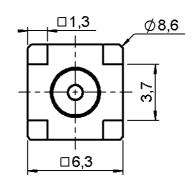
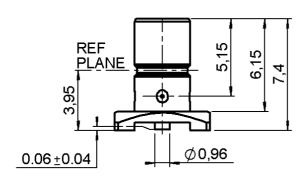
MALE STRAIGHT RECEPTACLE FOR PCB SMT TYPE

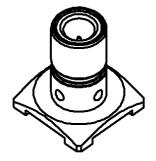
R114.424.000

Series : SMB









All dimensions are in mm.



COMPONENTS	MATERIALS	PLATINGS (µm)	
BODY CENTER CONTACT OUTER CONTACT INSULATOR GASKET OTHERS PARTS	BRASS BRASS - PTFE	GOLD 0.2 OVER NICKEL 2 GOLD 0.5 OVER NICKEL 2	

Issue: 0847 C



MALE STRAIGHT RECEPTACLE FOR PCB

SMT TYPE

R114.424.000

Series: SMB

PACKAGING

Standard	Unit	Other
100	'W' option	Contact us

SPECIFICATION

ELECTRICAL CHARACTERISTICS

Impedance 50 Ω

Frequency **0-4** GHz

VSWR 1.05* + 0,0080 x F(GHz) Maxi

Insertion loss

0.03* \(\sqrt{F(GHz)} \) dB Maxi

RE leakage

(57 - F(GHz)) dB mini

RF leakage - (57 - F(GHz)) dB mini Voltage rating 500 Veff Maxi

Dielectric withstanding voltage Insulation resistance Insulation 1000 Veff mini Insulation resistance Insulation 1000 M Ω mini

ENVIRONMENTAL

Operating temperature -65/+165 ° C

Hermetic seal NA Atm.cm3/s

Panel leakage NA

OTHERS CHARACTERISTICS

Assembly instruction

Others:

* Coaxial Transmission Line Only

MECHANICAL CHARACTERISTICS

Center contact retention

Axial force – Mating end
Axial force – Opposite end
Torque

10 N mini
NA N.cm mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 500 Cycles mini

Weight **0,4820** g

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MALE STRAIGHT RECEPTACLE FOR PCB

Series: SMB

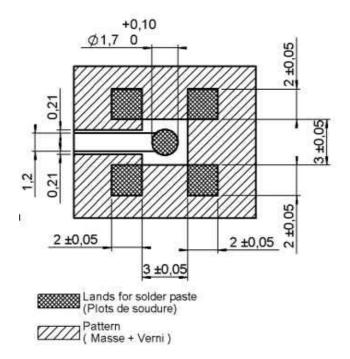
R114.424.000

SMT TYPE

SMBSERIES – INFORMATION

Coplanar line: pattern and signal are on the same side. Thickness of PCB: 1.6 mm

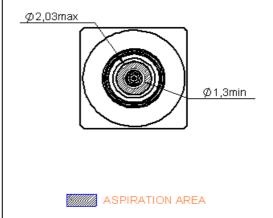
The material of PCB is the epoxy resin of glass fabrics bacs. (Er=4.8). The solder resist should be printed exept for the land pattern on the PCB.



SHADOW OF SMB RECEPTACLE FOR VIDEO CAMERA

Ø8,75

ASRIRATION AREA



Issue: 0847 C



MALE STRAIGHT RECEPTACLE FOR PCB **SMT TYPE**

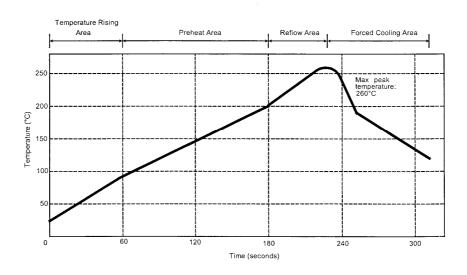
R114.424.000

Series: SMB

SOLDER PROCEDURE

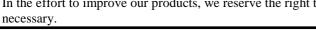
- 1. Deposit solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.
 - We advise a thickness of 150 micromm (5.850 microinch). Verify that the edges of the zone are clean.
- Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type.
- Soldering by infra-red reflow.
- Cleaning of printed circuit boards.
- Checking of solder joints and position of the component by visual inspection.

TEMPERATURE PROFILE



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to -4	°C/sec
Max dwell time above 100°C	420	sec

Issue: 0847 C





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